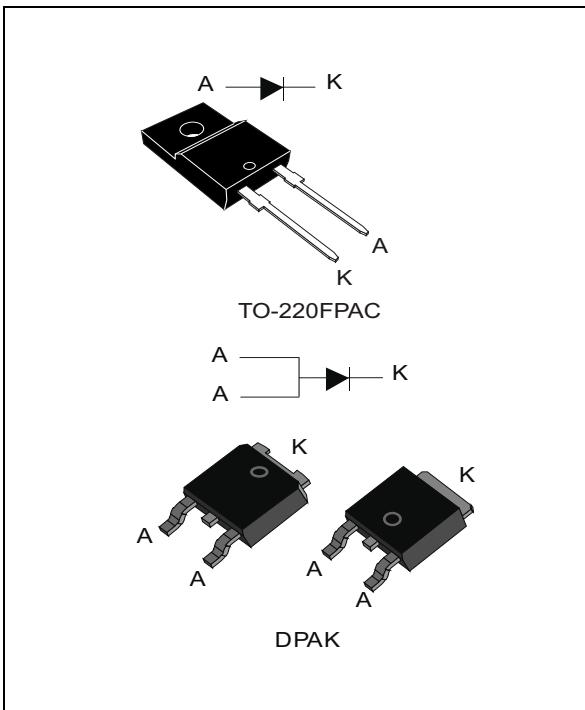


## Turbo 2 ultrafast - high voltage rectifier for flat panel displays

Datasheet - production data



### Description

The STTH10LCD06 uses ST Turbo 2 technology. This device is suited for power applications in flat panel displays and especially applicable to switching power supplies in LCD.

**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	10 A
$V_{RRM}$	600 V
$T_j(\max)$	175 °C
$V_F$ (typ)	1.3 V
$t_{rr}$ (typ)	35 ns

### Features

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduce conduction and switching losses
- ECOPACK®2 compliant component for DPAK on demand
- Insulated package: TO-220FPAC
  - Insulated voltage: 2000 V<sub>RMS</sub> sine

# 1 Characteristics

**Table 2. Absolute ratings (limiting values at 25 °C, unless otherwise stated)**

Symbol	Parameter			Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage			600	V		
I <sub>F(RMS)</sub>	RMS forward current	DPAK		18	A		
		TO-220FPAC		35			
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$ , square wave	DPAK	T <sub>c</sub> = 105 °C	10	A		
		TO-220FPAC	T <sub>c</sub> = 55 °C				
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms Sinusoidal		100	A		
T <sub>stg</sub>	Storage temperature range			-65 to + 175	°C		
T <sub>j</sub>	Maximum operating junction temperature <sup>(1)</sup>			175	°C		

1.  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal resistance**

Symbol	Parameter			Value	Unit
R <sub>th(j-c)</sub>	Junction to case	DPAK		3.5	°C/W
		TO-220FPAC		6	

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>			5	μA
		T <sub>j</sub> = 150 °C			13	130	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A			2	V
		T <sub>j</sub> = 150 °C			1.3	1.6	

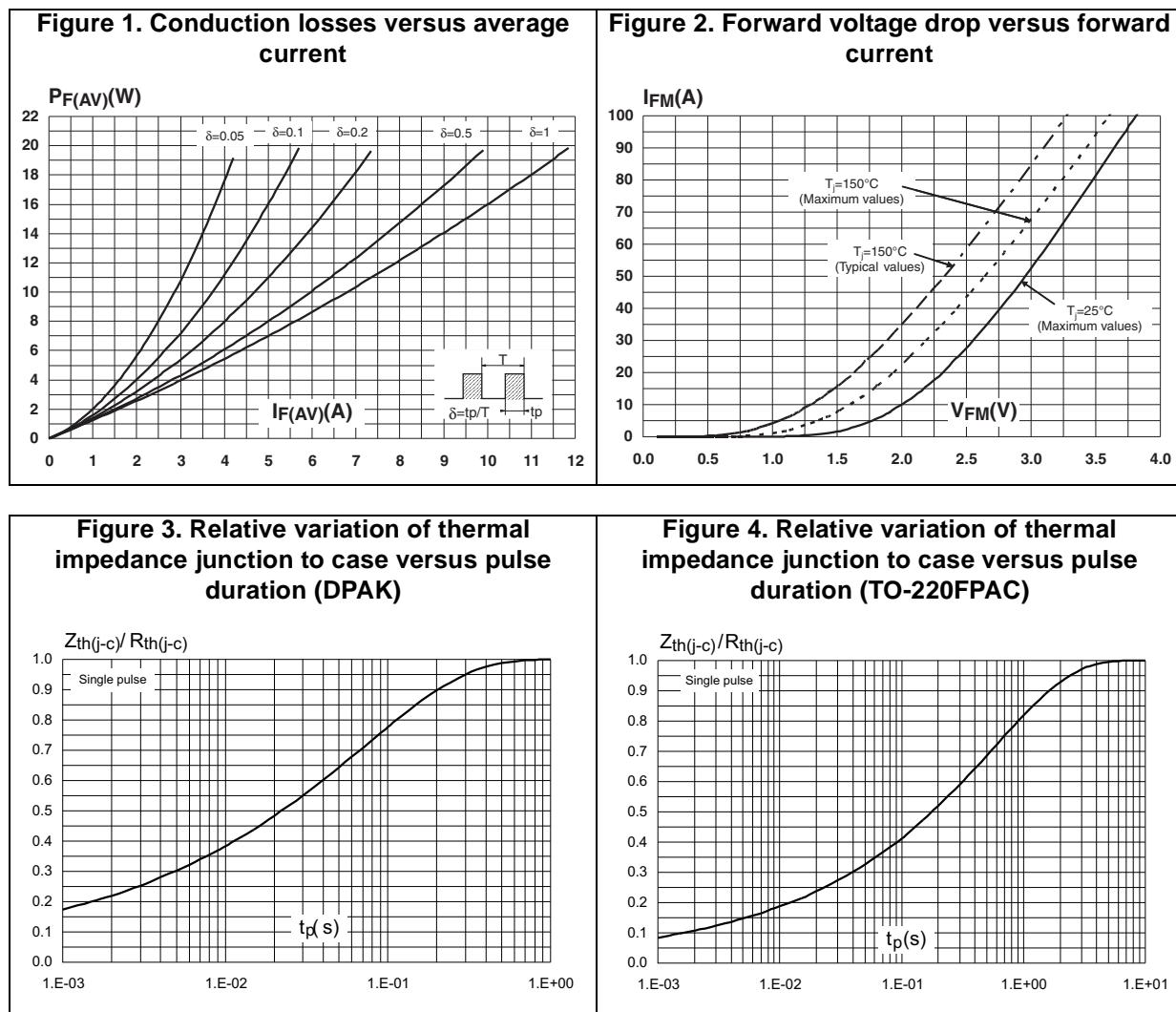
1. Pulse test: t<sub>p</sub> = 5 ms, δ < 2%
2. Pulse test: t<sub>p</sub> = 380 μs, δ < 2%

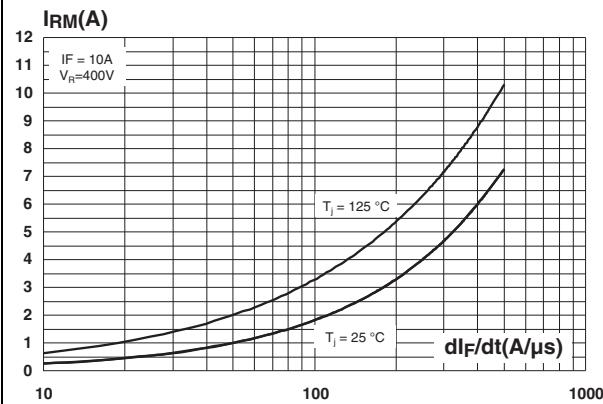
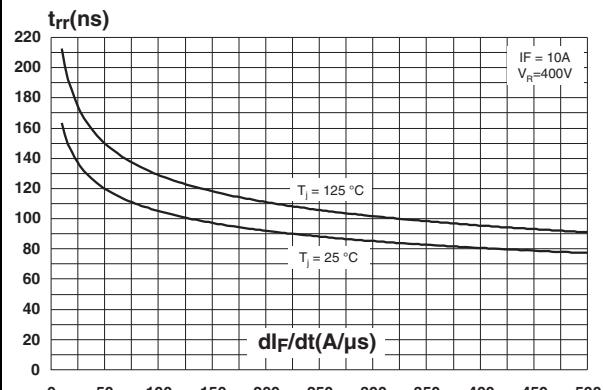
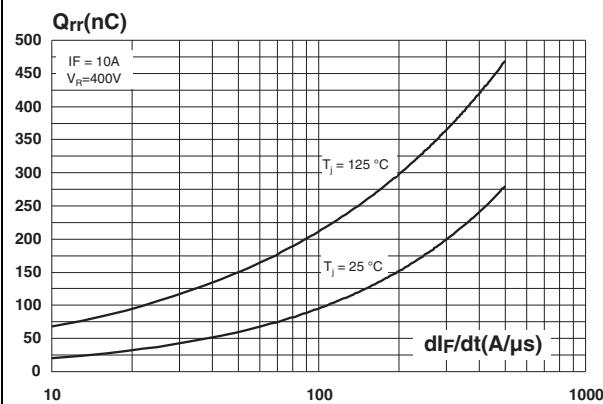
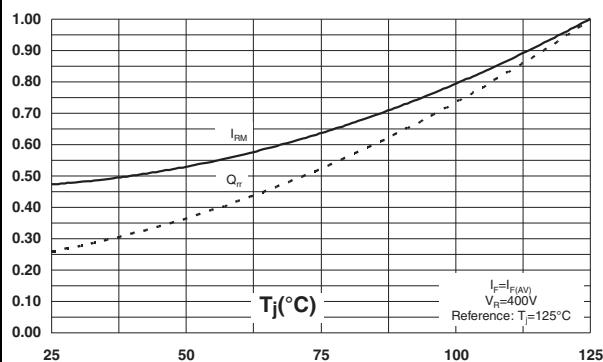
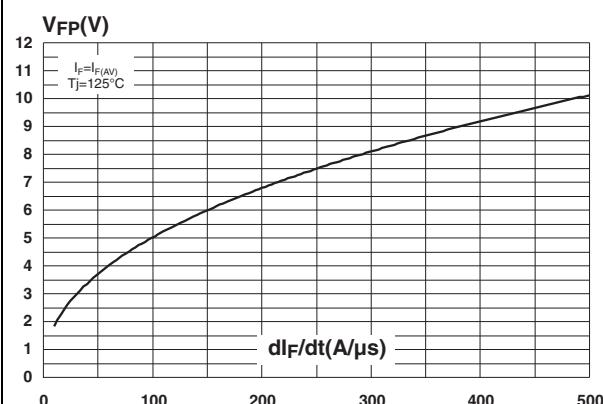
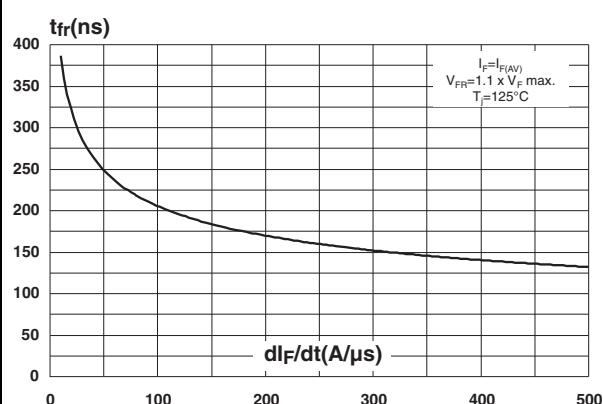
To evaluate the conduction losses use the following equation:

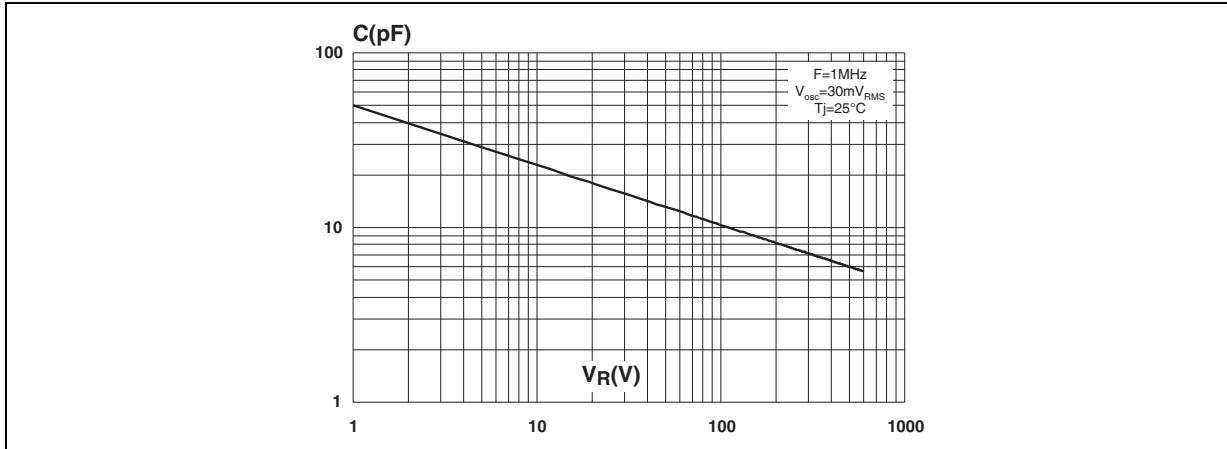
$$P = 1.20 \times I_{F(AV)} + 0.040 I_F^2 (RMS)$$

**Table 5. Dynamic characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$I_F = 1 \text{ A}, dI_F/dt = -50 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, T_j = 25^\circ\text{C}$		35	50	ns
$I_{RM}$	Reverse recovery current	$I_F = 10 \text{ A}, dI_F/dt = -50 \text{ A}/\mu\text{s}, V_R = 400 \text{ V}, T_j = 125^\circ\text{C}$		2.0	2.8	A
$t_{fr}$	Forward recovery time	$I_F = 10 \text{ A} \quad dI_F/dt = 100 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}, T_j = 25^\circ\text{C}$			230	ns
$V_{FP}$	Forward recovery voltage	$I_F = 10 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}, V_{FR} = 1.1 \times V_{Fmax}, T_j = 25^\circ\text{C}$		4		V



**Figure 5. Peak reverse recovery current versus  $dI_F/dt$  (typical values)****Figure 6. Reverse recovery time versus  $dI_F/dt$  (typical values)****Figure 7. Reverse recovery charges versus  $dI_F/dt$  (typical values)****Figure 8. Relative variations of dynamic parameters versus junction temperature****Figure 9. Transient peak forward voltage versus  $dI_F/dt$  (typical values)****Figure 10. Forward recovery time versus  $dI_F/dt$  (typical values)**

**Figure 11. Junction capacitance versus reverse voltage applied (typical values)**

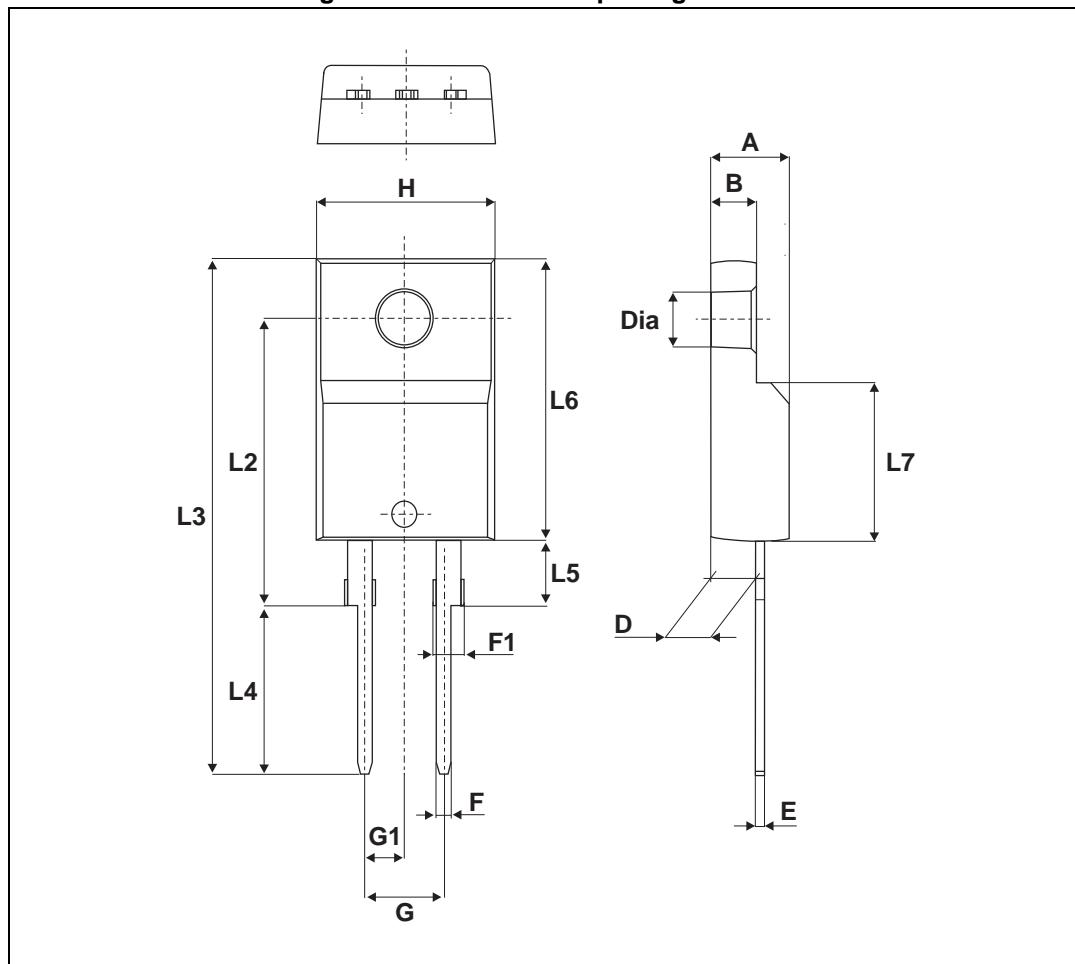
## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque values: 0.55 N·m for TO-220FPAC
- Maximum torque value: 0.7 N·m for TO-220FPAC

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

### 2.1 TO-220FPAC package information

Figure 12. TO-220FPAC package outline

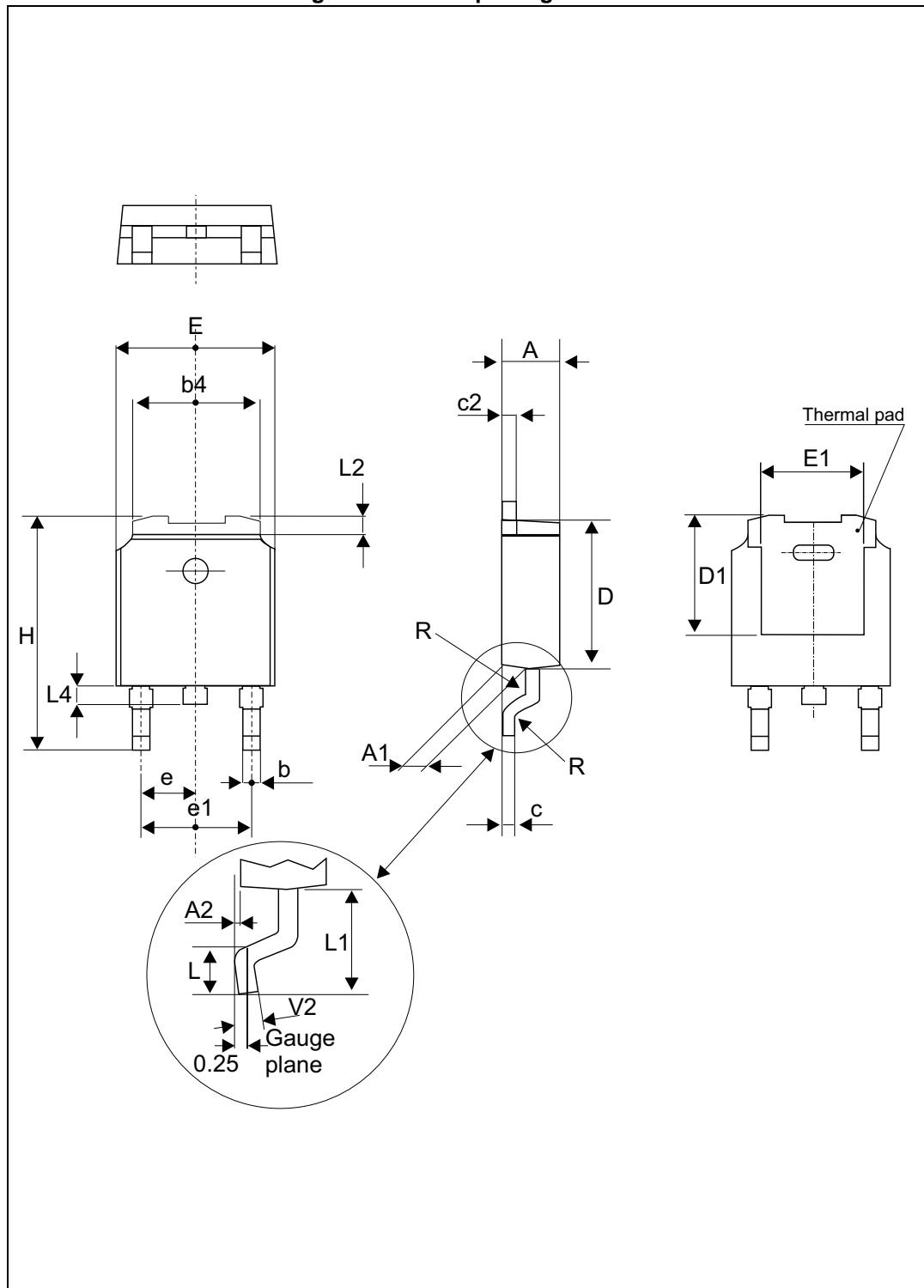


**Table 6. TO-220FPAC package mechanical data**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	2.50		2.70	0.098		0.106
D	2.50		2.75	0.098		0.108
E	0.45		0.70	0.018		0.027
F	0.75		1.00	0.030		0.039
F1	1.15		1.70	0.045		0.067
G	4.95		5.20	0.195		0.205
G1	2.40		2.70	0.094		0.106
H	10.00		10.40	0.393		0.409
L2		16.00 Typ.			0.630 Typ.	
L3	28.60		30.60	1.126		1.205
L4	9.80		10.60	0.386		0.417
L6	15.90		16.40	0.626		0.646
L7	9.00		9.30	0.354		0.366
Dia.	3.00		3.20	0.118		0.126

## 2.2 DPAK package information

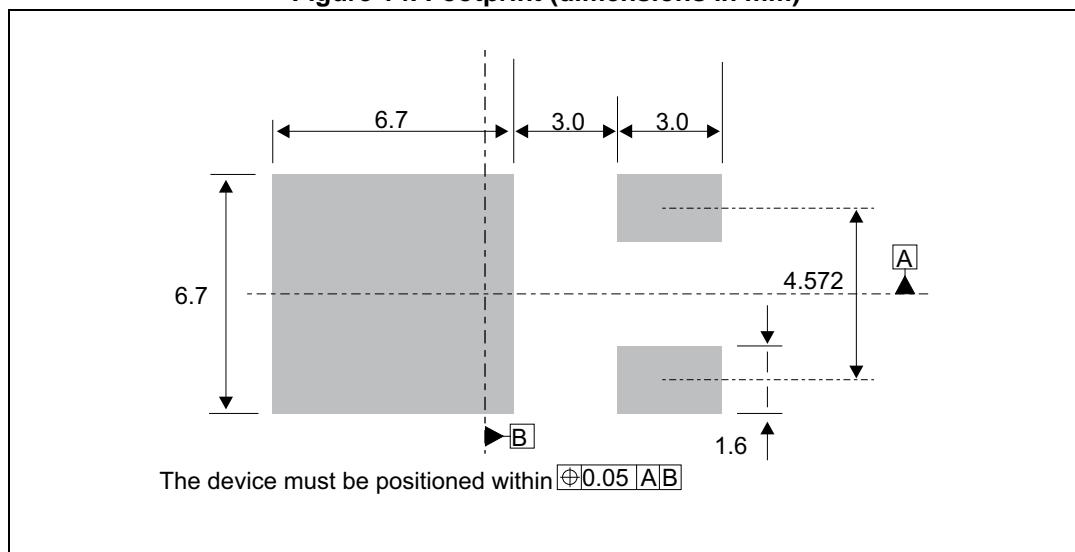
Figure 13. DPAK package outline



**Note:** This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

**Table 7. DPAK package mechanical data**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
c	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95			0.194		
E	6.35		6.73	0.250		0.264
E1	4.32			0.170		
e		2.28			0.090	
e1	4.40		4.70	0.173		0.185
H	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

**Figure 14. Footprint (dimensions in mm)**

### 3 Ordering information

**Table 8. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH10LCD06FP	STTH10LCD06FP	TO-220FPAC	1.9 g	50	Tube
STTH10LCD06SB-TR	TH10LCD06S	DPAK	1.8 g	2500	Tape and reel

### 4 Revision history

**Table 9. Document revision history**

Date	Revision	Changes
14-May-2008	1	First issue.
23-Oct-2008	2	Updated DPAK package information and reformatted to current standard.
13-Nov-2015	3	Removed TO-220FPAC and D <sup>2</sup> PAK package information. Updated DPAK package information and reformatted to current standard.

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